

NPN SILICON RF TRANSISTOR

Applications

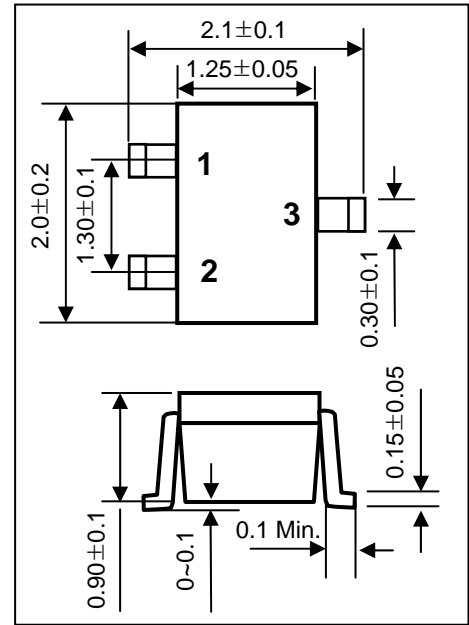
- UHF and VHF wide band amplifier

Features

- High gain bandwidth product
 $f_T = 6 \text{ GHz @ } V_{CE} = 3 \text{ V, } I_C = 10 \text{ mA}$
 $f_T = 7.5 \text{ GHz @ } V_{CE} = 5 \text{ V, } I_C = 20 \text{ mA}$
- High power gain
 $|S_{21}|^2 = 9 \text{ dB @ } V_{CE} = 3 \text{ V, } I_C = 10 \text{ mA, } f = 1 \text{ GHz}$
- Low noise figure
 $NF = 1.4 \text{ dB @ } V_{CE} = 3 \text{ V, } I_C = 10 \text{ mA, } f = 1 \text{ GHz}$

SOT323

Unit in mm



Pin Configuration (TBN6301U)

1. Base
2. Emitter
3. Collector

Absolute Maximum Ratings (T_A = 25 °C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	BV_{CBO}	20	V
Collector to Emitter Voltage	BV_{CEO}	8	V
Emitter to Base Voltage	BV_{EBO}	3	V
Collector Current	I_C	75	mA
Total Power Dissipation	P_{tot}	150	mW
Operating Junction Temperature	T_j	150	°C
Storage Temperature	T_{stg}	-65 ~ 150	°C

Caution : Electro Static Discharge sensitive device

Electrical Characteristics ($T_A = 25\text{ }^\circ\text{C}$)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Collector Cut-off Current	I_{CBO}	$V_{CB} = 15\text{ V}, I_E = 0\text{ mA}$			0.5	μA
	I_{CEO}	$V_{CE} = 8\text{ V}, I_B = 0\text{ mA}$			10	μA
Emitter Cut-off Current	I_{EBO}	$V_{EB} = 2\text{ V}, I_C = 0\text{ mA}$			0.5	μA
DC Current Gain	h_{FE}	$V_{CE} = 3\text{ V}, I_C = 10\text{ mA}$	50		250	
Gain Bandwidth Product	f_T	$V_{CE} = 3\text{ V}, I_C = 10\text{ mA}$	5	6		GHz
		$V_{CE} = 5\text{ V}, I_C = 20\text{ mA}$	6	7.5		GHz
Insertion Power Gain	$ S_{21} ^2$	$V_{CE} = 3\text{ V}, I_C = 10\text{ mA}, f = 1\text{ GHz}$	7	9		dB
		$V_{CE} = 5\text{ V}, I_C = 20\text{ mA}, f = 1\text{ GHz}$	7	9.5		dB
Noise Figure	NF	$V_{CE} = 3\text{ V}, I_C = 10\text{ mA}, f = 1\text{ GHz}$		1.4	1.8	
Reverse Transfer Capacitance	C_{re}	$V_{CB} = 3\text{ V}, I_E = 0\text{ mA}, f = 1\text{ MHz}$		1.1		pF

h_{FE} Classification

Marking	SB2	SB1
h_{FE} Value	50 - 160	125 - 250

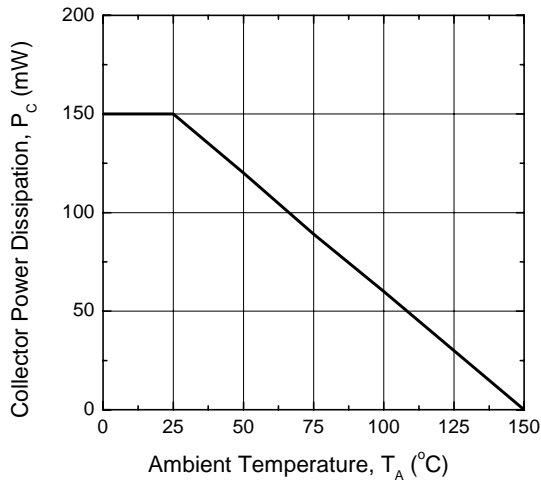
Available Package

Unit in mm

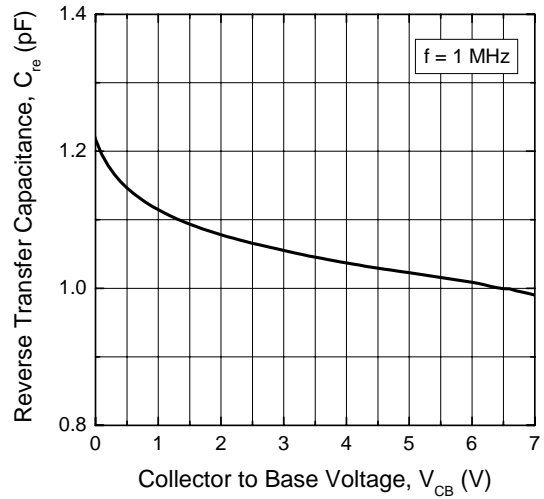
Product	Package	Dimension
TBN6301S	SOT23	2.9 x 1.3, 1.2t
TBN6301U	SOT323	2.0 x 1.25, 1.0t
TBN6301E	SOT523	1.6 x 0.8, 0.8t
TBN6301KF	SOT623F	1.4 x 0.8, 0.6t

□ Typical Characteristics ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

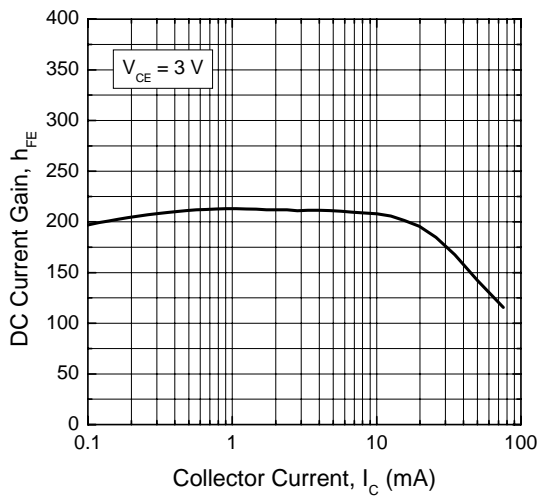
Power Dissipation vs. Ambient Temperature



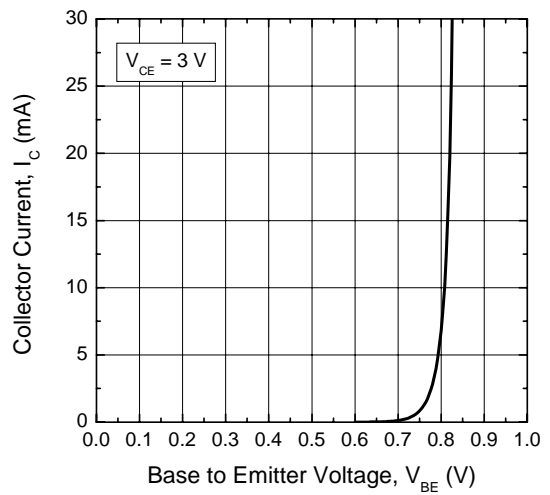
Reverse Transfer Capacitance vs. Collector to Base Voltage



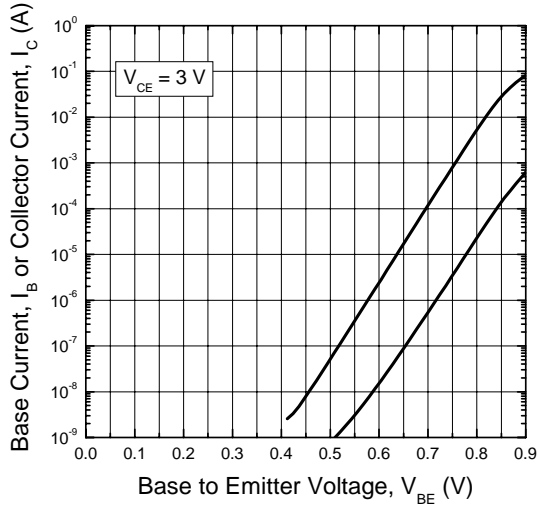
DC Current Gain vs. Collector Current



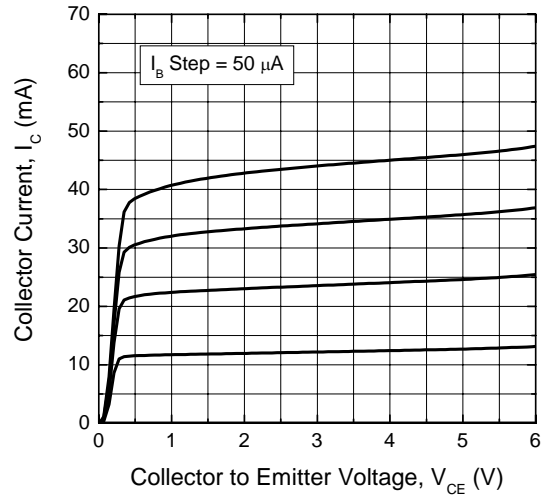
Collector Current vs. Base to Emitter Voltage



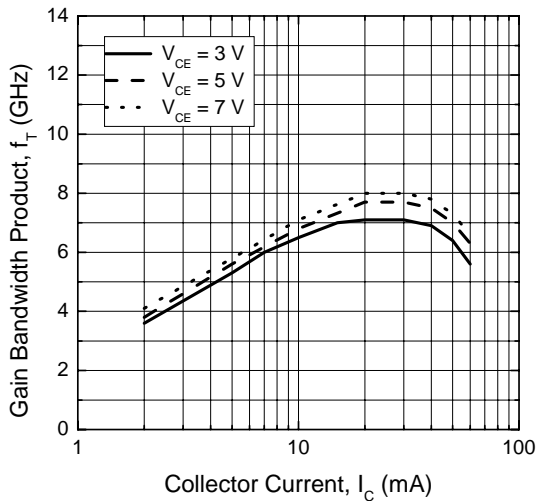
Base Current, Collector Current vs. Base to Emitter Voltage



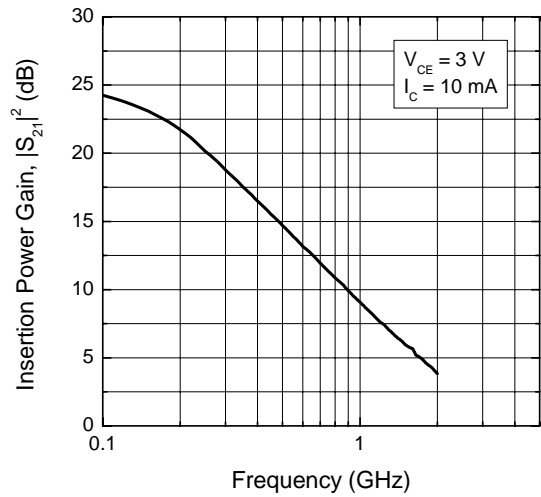
Collector Current vs. Collector to Emitter Voltage



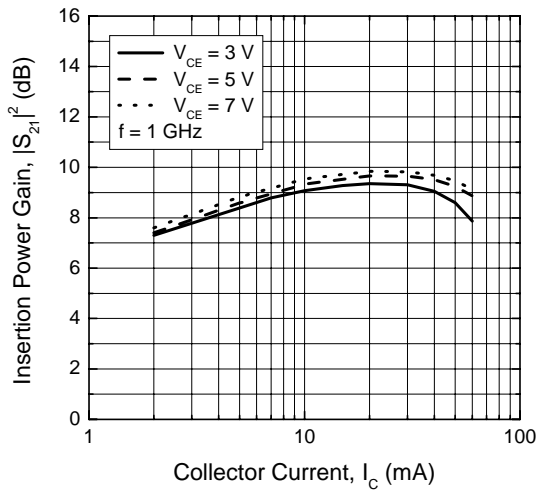
Gain Bandwidth Product vs. Collector Current



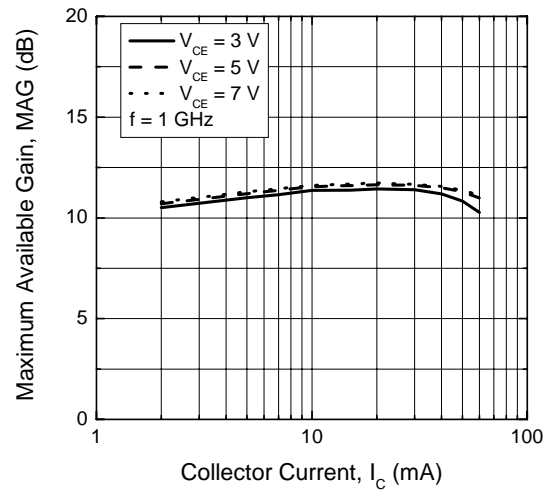
Insertion Power Gain vs. Frequency



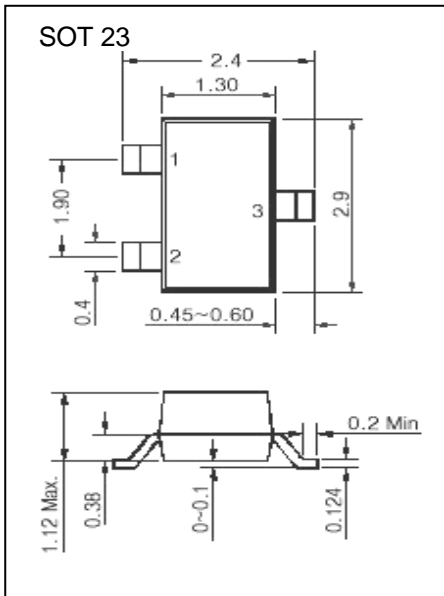
Insertion Power Gain vs. Collector Current



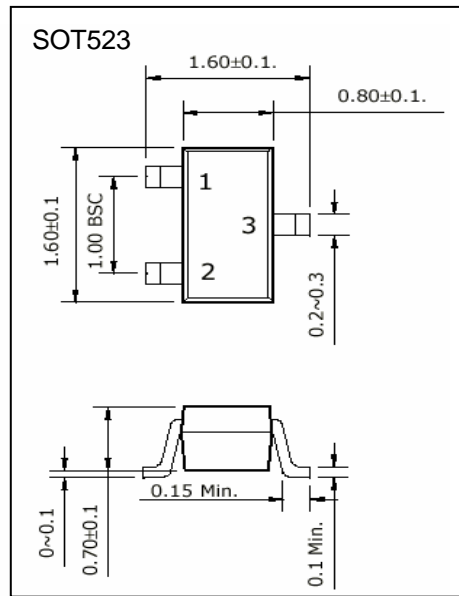
Maximum Available Gain vs. Collector Current



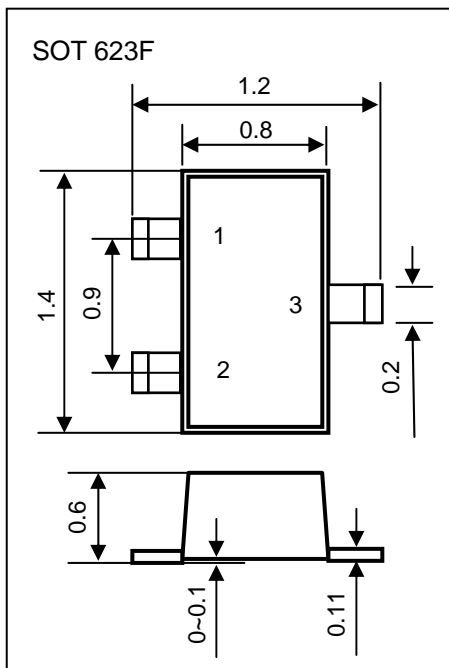
□ Dimensions of TBN6301S in mm



□ Dimensions of TBN6301E in mm



□ Dimensions of TBN6301KF in mm



Pin Configuration

(SOT23, SOT523, SOT623F)

Pin No.	Symbol	Description
1	B	Base
2	E	Emitter
3	C	Collector